CT25203

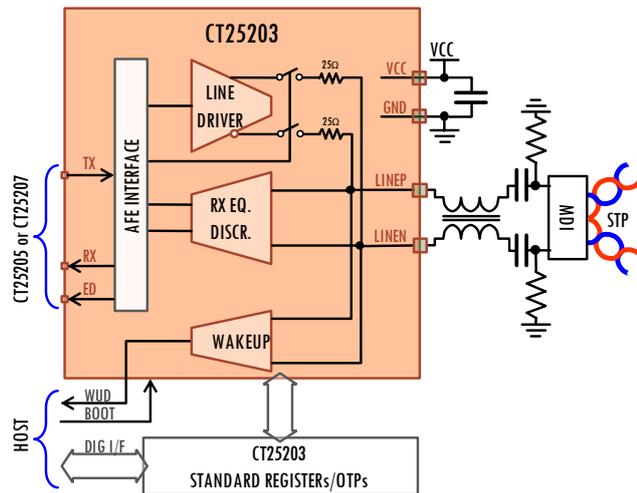## IEEE 802.3cg® 10BASE-T1S Analog Front-End

Status

- Silicon-Proven (BCD silicon processes)
- Fully characterized
- EMI tested
- In mass production

Deliverables

- Datasheet
- GDS2 and LVS Netlist
- Footprint (.LEF)
- Test Specifications
- Integration guidelines
- Reference Design

Applications

- Automotive Networks
- Industrial Networks

Features

- Compliant to:
  - IEEE 802.3cg® specifications
  - OPEN Alliance TC14 Interoperability Specifications
  - OPEN Alliance TC14 EMC Specifications
  - OPEN Alliance TC14 System Implementation
- One-fits-all Analog Macro for implementing:
  - IEEE 802.3cg® 10BASE-T1S Physical Layer
  - OPEN Alliance TC6 10BASE-T1S MACPHY
  - OPEN Alliance TC14 10BASE-T1S PMD I/F
- Single min 3.3V supply
- Low Power consumption meeting OPEN Alliance TC10 requirement in sleep mode
- OPEN Alliance TC10 Wake Up detection
- Voltage and current references, test infrastructures, included
- Supply regulators, 25MHz XTAL and x4 (100MHz) DLL available upon request in the target silicon process.

Description

The CT25203 implements the analog front end of an IEEE 802.3cg® 10BASE-T1S physical layer.

It can be used in conjunction to other analog and digital blocks like (a) the CT25205 to implement a complete physical layer ethernet device, (b) the CT25207 to implement a complete OPEN Alliance PMD Interface and (c) the CT25209, the CT25208 and the CT25205 to implement a complete OPEN Alliance MACPHY (see next page for details).

The CT25203 has been designed in GlobalFoundries 130n-BCD process but also successfully and timely ported in other BCD silicon process technologies.

Availability of a complete IEEE physical layer Test Chip vehicle (CT25205_TC) and Evaluation Boards.

The BCD process is required to meet all EMI directives to be used in the Automotive and Industrial environments.
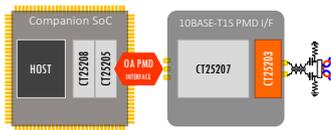
R1.1 — 2212

Q: Which kind of IC products I can develop using Canova Tech 10BASE-T1S silicon IPs solution?
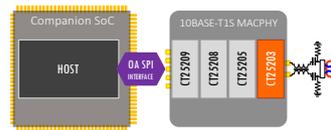**A:** Among others, here're some product examples you can develop with our 10BASE-T1S silicon IPs:

OPEN Alliance 10BASE-T1S PMD Interface IC **+** Companion SoC/FPGA	OPEN Alliance 10BASE-T1S MACPHY **+** Companion low-end MCU/FPGA	Sensor with integrated 10BASE-T1S interface	10BASE-T1S IEEE PHY **+** Companion Ethernet SoC

This 2-chip 10BASE-T1S networking solution mimics the CAN partition.

The **CT25203** Analog Front-End plus the **CT25207** PMD Controller are integrated, using BCD silicon technology process, in a single low pin-count tiny and low-cost chip. By means of the standardized OPEN Alliance three-pin PMD Interface, it then connects to the SoC which integrates the Host, the **CT25208** Ethernet MAC, if needed, and the **CT25205** digital PHY in a pure digital silicon technology.
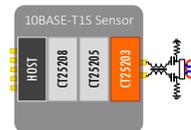
This innovative 2-chip 10BASE-T1S networking solution is based on the standardized OPEN Alliance SPI MACPHY Interface.

A single low pin-count, tiny "MACPHY" chip, made using BCD silicon technology process, integrates the **CT25203** Analog Front-End, the **CT25205** digital PHY, the **CT25208** Ethernet MAC and the **CT25209** SPI Protocol Handler. A low-end companion SoC/FPGA, is then connected to the MACPHY via a standard SPI interface.
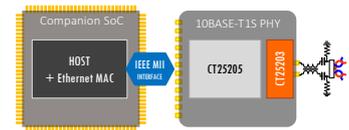
Automotive and Industrial sensors often integrate LIN and/or CAN interface in a single chip solution using BCD silicon technology.

The substitution of LIN and/or CAN interfaces with 10BASE-T1S Ethernet can be then realized by means of the **CT25203** Analog Front-End, the **CT25205** digital PHY and the **CT25208** Ethernet MAC directly connected to the Host Sensor in a similar way of LIN and/or CAN.

This is the "classical" Ethernet networking solution.

A standard 10BASE-T1S PHY integrates the **CT25203** Analog Front-End plus the **CT25205** digital PHY in a BCD silicon technology connecting, via the IEEE standard MII/MDIO Interface, to a companion Ethernet controller SoC. The world-first 10BASE-T1S PHY, in form of Test Chip vehicle and based upon the **CT25203** and the **CT25205**, has been released by Canova Tech in 2018. Have a look here for details.

Q: Are there any way to test the Canova Tech 10BASE-T1S silicon IPs solution?
A: Yes, by subscribing the "Early Access" program you can receive our development boards described here and the related technical support. Contact us for commercial details.

Q: Why the 10BASE-T1S front-end requires to be implemented on BCD technologies?
A: Because of the nature of the multi-drop network which obliges the silicon interface to expose high value of impedance to the line. In fact, in presence of severe electromagnetic radiations induced on the twisted-pair, the line common-mode voltage can then reach the silicon with high-voltage peaks of ± tens of Volts. The BCD process ensure proper protection of the silicon against damages and avoid degradations of the quality of the communication in those severe conditions. Contact us for checking if your target silicon process can be used for implementing the 10BASE-T1S front-end.

Q: May I ask Canova Tech to develop custom and dedicated analog and/or digital on top of the IPs?
A: Yes, you can. Our business model includes custom and dedicated Design Services to facilitate the integration of our IPs into your chip architecture. This business model includes the possibility for you to assign Canova the responsibility for design of a complete integrated circuit (GDS IP) based upon our IPs and your requirements.

Q: Is 10BASE-T1S protected by Standard-Essential Patents (like for CAN, 100BASE-T1, etc.)?
A: Yes, it is. the Physical-Layer Collision Avoidance Reconciliation sub-layer (clause 148 of the IEEE 802.3cg® standard) has been invented and patented by Canova Tech. We're always available to license it to you on the basis of FRAND (Fair, Reasonable and Non-Discriminatory) conditions already applied to several active licensee of Canova Tech's Intellectual Property Rights. Contact us for setting the required NDA and receive the PLCA Patent Agreement.

Q: Which options do I have for licensing the Canova Tech 10BASE-T1S silicon IPs solution?
A: You can have several licensing options which includes:
- single-use/multiple-use license: the IPs (single or in bundle) are delivered as object-code and licensed for the use on a well-defined product code (single-use) or for unlimited product codes (multiple-use).
- architectural license: the IPs (single or in bundle) are delivered as source-code (plus know-how transfer) and licensed for the use on unlimited product codes.
- manufacturing license: here Canova Tech can develop your entire product, based upon our IPs (single or in bundle) and your product specifications. The GDS IP is licensed and delivered to you (including all necessary documentation and support) for you to manufacture your product and brand it.

Q: What kind of Support and IP Maintenance will I get from Canova?
A: You will get all required Support and IP Maintenance to ensure proper IP integration into your products for 12 months following the IP licensing. You can then subscribe, at your option, annual renewals of the Support and Maintenance agreement.